

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Inventor: **Martin W. Weiser**  
Serial No: **10/670319**  
Filed: **September 26, 2003**  
For: **SEMICONDUCTOR  
PACKAGES, AND LEAD-  
CONTAINING SOLDERS AND  
ANODES**

Examiner: **Dilinh P. Nguyen**  
Art Unit: **2814**

**PRELIMINARY AMENDMENT**

**MAIL STOP RCE  
COMMISSIONER OF PATENTS  
P.O. Box 1450  
ALEXANDRIA, VA 22313-1450**

Dear Sir:

This paper responds to the Final Office Action dated July 30, 2007. Please note that the 5-month deadline fell on Sunday, December 30, 2007, and therefore, this preliminary amendment is timely filed on Monday, December 31, 2007. Please enter the following:

**CLAIMS AMENDMENTS:** Begin on Page 2

**SPECIFICATION AMENDMENTS:** Begin on Page 3

**FIGURES AMENDMENTS:** None

**REMARKS SECTION:** Begins on Page 4